

TRENCHSTOP™ Series

Low Loss DuoPack : IGBT in TRENCHSTOP[™] and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode



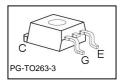




Features

- Very low V_{CE(sat)} 1.5V (typ.)
- Maximum Junction Temperature 175°C
- Short circuit withstand time 5µs
- Designed for frequency inverters for washing machines, fans, pumps and vacuum cleaners
 - TRENCHSTOP[™] and Fieldstop technology for 600V applications offers :
 - very tight parameter distribution
 - high ruggedness, temperature stable behavior
 - very high switching speed
- Low EMI
- Qualified according to JEDEC¹ for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <u>http://www.infineon.com/igbt/</u>





Туре	V _{CE}	I _{C;Tc=100°C}	V _{CE(sat), Tj=25°C}	T _{j,max}	Marking	Package
IKB06N60T	600V	6A	1.5V	175°C	K06T60	PG-TO263-3

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage, $T_j \ge 25^{\circ}C$	V _{CE}	600	V
DC collector current, limited by T_{jmax}			
$T_{\rm C} = 25^{\circ}{\rm C}$	I _C	12	
$T_{\rm C} = 100^{\circ}{\rm C}$		6	
Pulsed collector current, t_p limited by T_{jmax}	I _{Cpuls}	18	•
Turn off safe operating area, $V_{CE} = 600V$, $T_j = 175^{\circ}C$, $t_p = 1\mu s$	-	18	A
Diode forward current, limited by T_{jmax}			
$T_{\rm C} = 25^{\circ}{\rm C}$	/ _F	12	
$T_{\rm C} = 100^{\circ}{\rm C}$		6	
Diode pulsed current, t_p limited by T_{jmax}	I _{Fpuls}	18	
Gate-emitter voltage	V _{GE}	±20	V
Short circuit withstand time ²⁾	4	F	
V_{GE} = 15V, $V_{\text{CC}} \le 400$ V, $T_{j} \le 150^{\circ}$ C	t _{sc}	5	μs
Power dissipation	л	00	14/
$T_{\rm C} = 25^{\circ}{\rm C}$	P _{tot}	88	W
Operating junction temperature	Tj	-40+175	
Storage temperature	T _{stg}	-55+150	°C
Soldering temperature (reflow soldering, MSL1)		260	

¹J-STD-020 and JESD-022

²⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



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Thermal Resistance

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				1
IGBT thermal resistance, junction – case	R _{thJC}		1.7	K/W
Diode thermal resistance, junction – case	R _{thJCD}		2.6	
Thermal resistance, junction – ambient	R _{thJA}		62	
Thermal resistance, junction – ambient	R _{thJA}	Footprint 6cm ² Cu	65 40	

Electrical Characteristic, at $T_j = 25$ °C, unless otherwise specified

Devementer	Cumbal	Conditions		Value		l Ini4
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
Static Characteristic	·	·				
Collector-emitter breakdown voltage	V _{(BR)CES}	V _{GE} =0V, I _C =0.25mA	600	-	-	V
Collector-emitter saturation voltage	V _{CE(sat)}	$V_{GE} = 15V, I_{C}=6A$ $T_{j}=25^{\circ}C$ $T_{j}=175^{\circ}C$	-	1.5 1.8	2.05	
Diode forward voltage	V _F	V _{GE} =0V, <i>I</i> _F =6A <i>T</i> _j =25°C	-	1.6	2.05	
		<i>T</i> _j =175°C	-	1.6	-	
Gate-emitter threshold voltage	V _{GE(th)}	$I_{\rm C}$ =0.18mA, $V_{\rm CE}$ = $V_{\rm GE}$	4.1	4.6	5.7	
Zero gate voltage collector current	I _{CES}	V _{CE} =600V, V _{GE} =0V				μA
		$T_j = 25 \degree C$ $T_j = 175 \degree C$	-	-	40 700	
Gate-emitter leakage current	I _{GES}	$V_{\rm CE}=0V, V_{\rm GE}=20V$	-	-	100	nA
Transconductance	$g_{\rm fs}$	$V_{\rm CE} = 20 \text{V}, \ I_{\rm C} = 6 \text{A}$	-	3.6	-	S
Integrated gate resistor	R _{Gint}			none		Ω

Dynamic Characteristic

Input capacitance	Ciss	$V_{\rm CE}=25V$,	-	368	-	pF
Output capacitance	Coss	$V_{\rm GE}=0V$,	-	28	-	
Reverse transfer capacitance	Crss	f=1MHz	-	11	-	
Gate charge	Q _{Gate}	V _{CC} =480V, <i>I</i> _C =6A V _{GE} =15V	-	42	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L _E		-	7	-	nH
Short circuit collector current ¹⁾	I _{C(SC)}	$V_{GE} = 15V, t_{SC} \le 5\mu s$ $V_{CC} = 400V,$ $T_{j} = 25^{\circ}C$	-	55	-	A

¹⁾ Allowed number of short circuits: <1000; time between short circuits: >1s.



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Switching Characteristic, Inductive Load, at T_i =25 °C

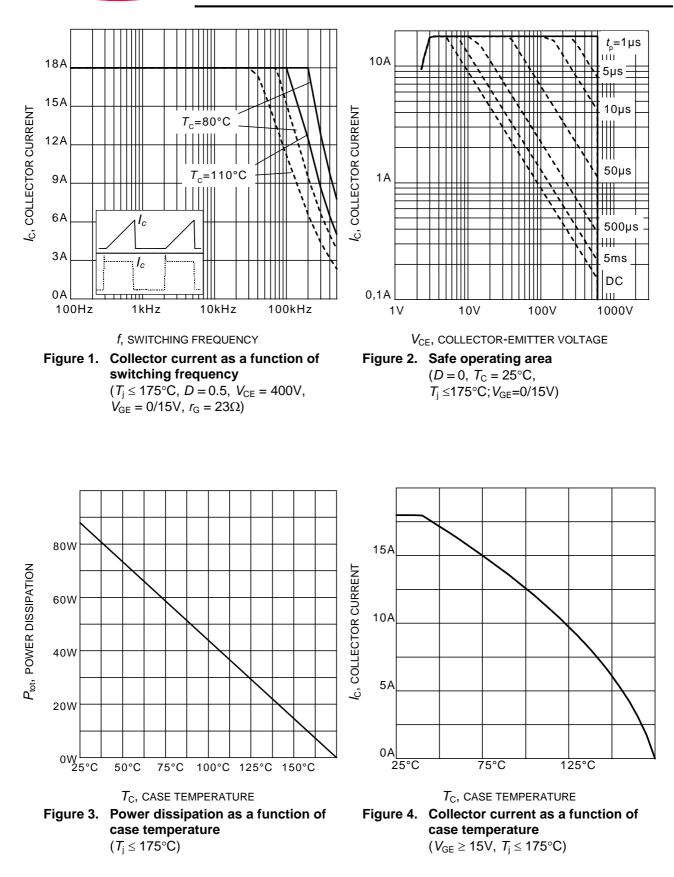
Parameter	Symbol	Conditions	Value			Unit
Parameter	Symbol	Conditions	min.	typ.	max.	Onit
IGBT Characteristic						
Turn-on delay time	t _{d(on)}	<i>T</i> _j =25°C,	-	9	-	ns
Rise time	t _r	$V_{\rm CC} = 400 \text{V}, I_{\rm C} = 6 \text{A},$ $V_{\rm GE} = 0/15 \text{V}, r_{\rm G} = 23 \Omega,$	-	6	-	
Turn-off delay time	$t_{d(off)}$	L_{σ} =60nH, C_{σ} =40pF	-	130	-	
Fall time	t _f]	-	58	-	
Turn-on energy	Eon	L_{σ} , C_{σ} from Fig. E Energy losses include	-	0.09	-	mJ
Turn-off energy	E _{off}	"tail" and diode reverse	-	0.11	-	
Total switching energy	Ets	recovery.	-	0.2	-	
Anti-Parallel Diode Characteristic						
Diode reverse recovery time	t _{rr}	<i>T</i> _j =25°C,	-	123	-	ns
Diode reverse recovery charge	Q _{rr}	V _R =400V, <i>I</i> _F =6A,	-	190	-	nC
Diode peak reverse recovery current	I _{rrm}	di _F /dt=550A/µs	-	5.3	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di _{rr} /dt		-	450	-	A/μs

Switching Characteristic, Inductive Load, at T_j=175 °C

Deveryor	Cumhal	Conditions		Value		11
Parameter	Symbol	Conditions	min.	typ.	max.	Unit
IGBT Characteristic						•
Turn-on delay time	t _{d(on)}	T _j =175°C,	-	9	-	ns
Rise time	t _r	$V_{\rm CC} = 400 \text{V}, I_{\rm C} = 6 \text{A},$ $V_{\rm GE} = 0/15 \text{V}, r_{\rm G} = 23 \Omega,$	-	8	-	
Turn-off delay time	t _{d(off)}	L_{σ} =60nH, C_{σ} =40pF	-	165	-	
Fall time	t _f]	-	84	-	
Turn-on energy	Eon	L_{σ} , C_{σ} from Fig. E Energy losses include	-	0.14	-	mJ
Turn-off energy	E _{off}	Energy losses include "tail" and diode reverse	-	0.18	-	
Total switching energy	Ets	recovery.	-	0.335	-	
Anti-Parallel Diode Characteristic						•
Diode reverse recovery time	t _{rr}	<i>T</i> _j =175°C	-	180	-	ns
Diode reverse recovery charge	Q _{rr}	V _R =400V, <i>I</i> _F =6A,	-	500	-	nC
Diode peak reverse recovery current	<i>I</i> _{rrm}	di _F /dt=550A/µs	-	7.6	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di _{rr} /dt		-	285	-	A/μs

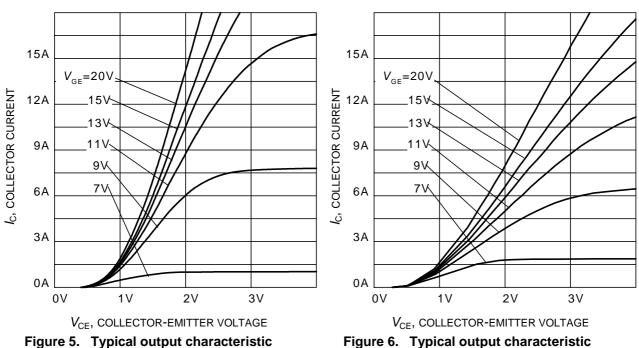


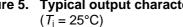
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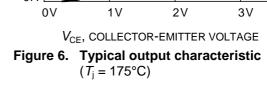


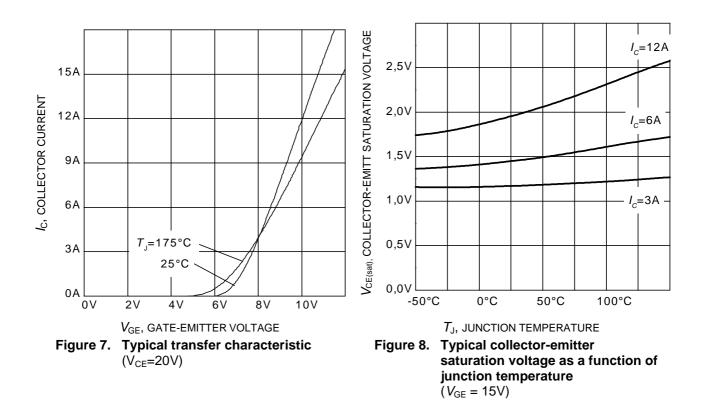


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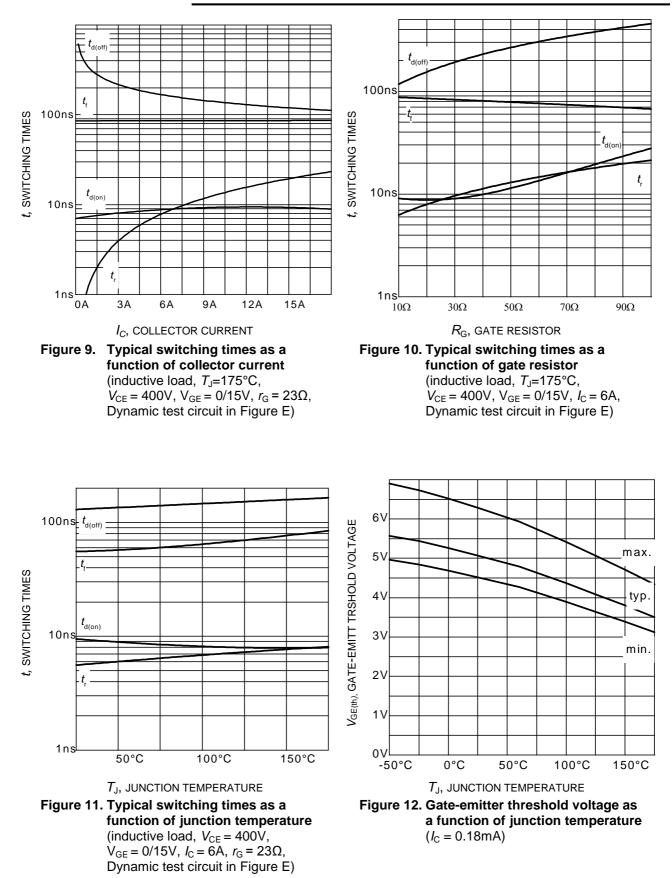






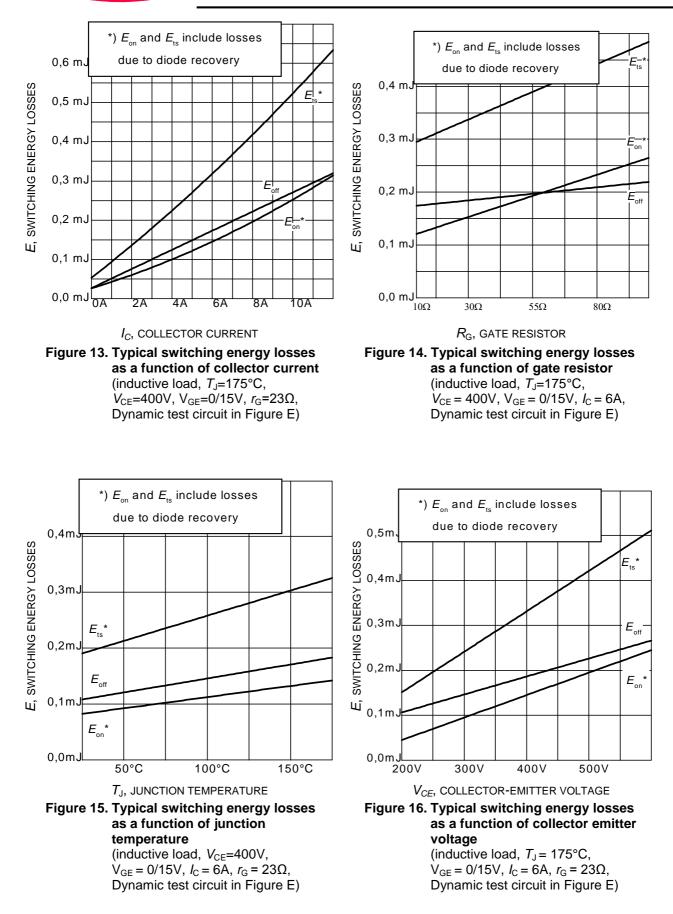




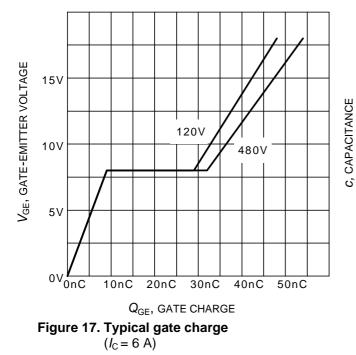












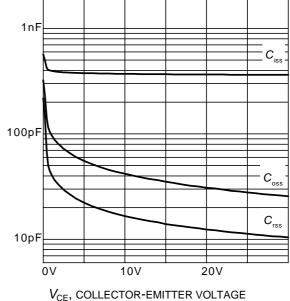
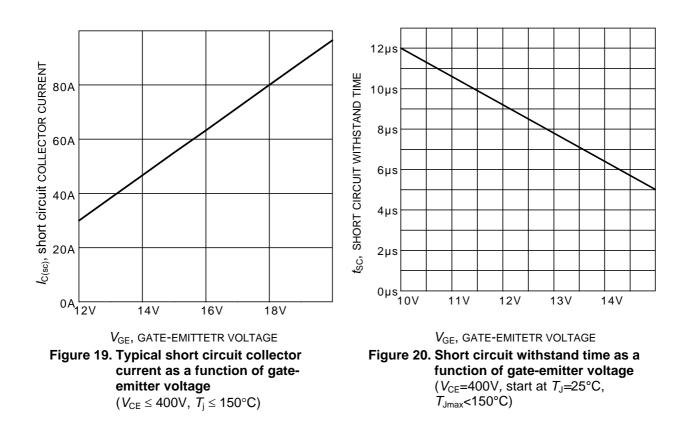


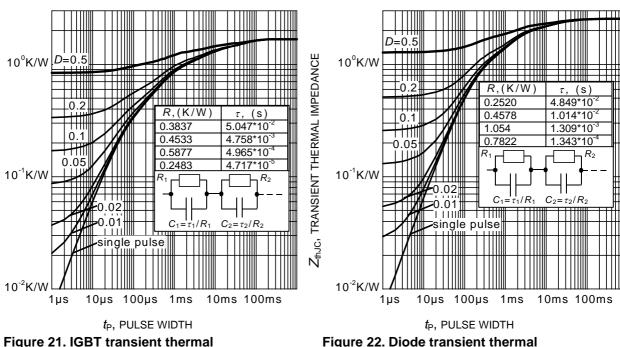
Figure 18. Typical capacitance as a function of collector-emitter voltage $(V_{GE}=0V, f = 1 \text{ MHz})$

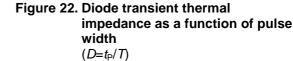




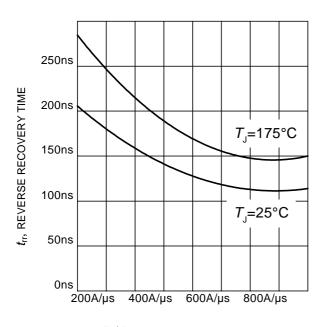
 $Z_{
m th}_{
m JC}$, TRANSIENT THERMAL IMPEDANCE

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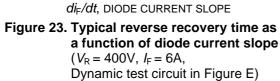


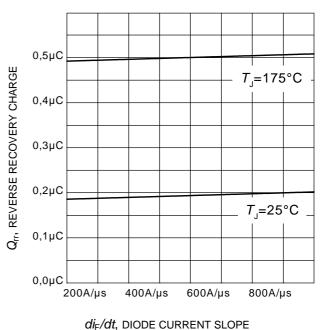
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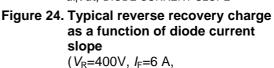


impedance

 $(D = t_{\rm D} / T)$



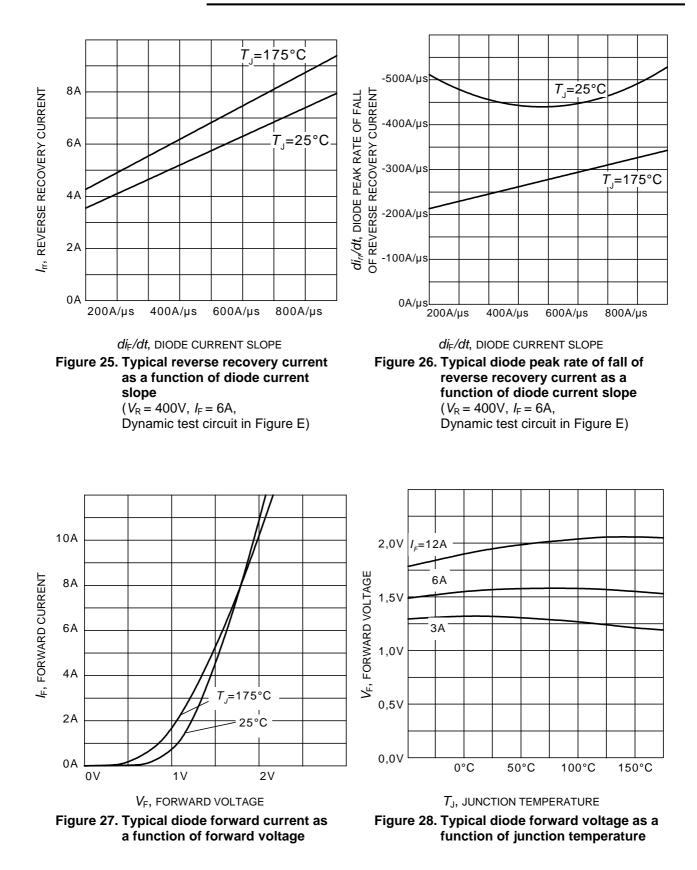




Dynamic test circuit in Figure E)

IFAG IPC TD VLS

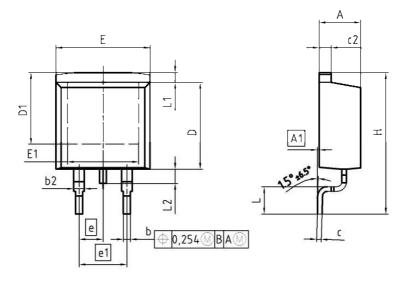


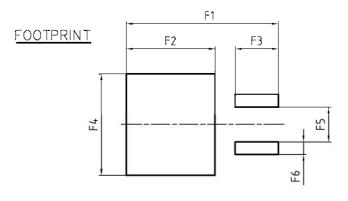




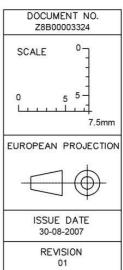
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PG-TO263-3



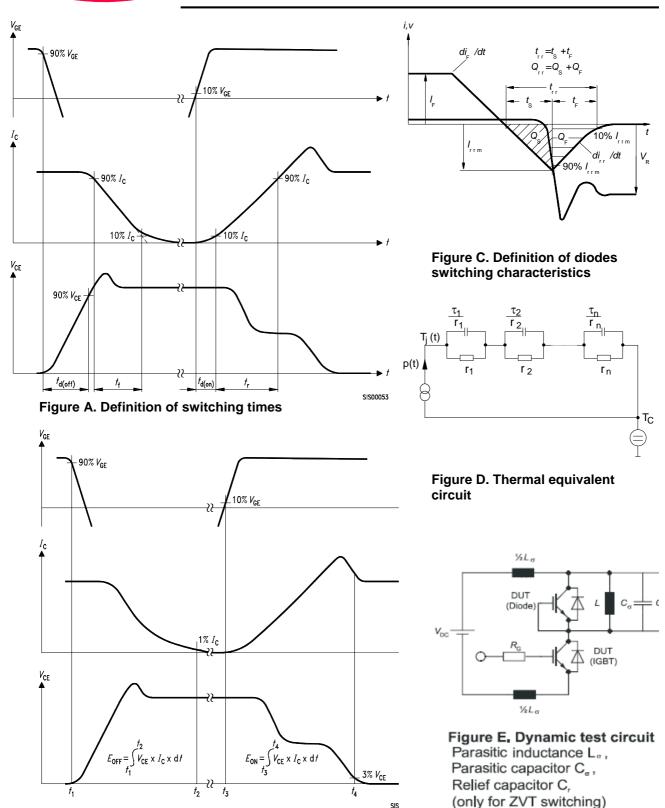


	IES	INCH	ETERS	MILLIM	DIM
	MAX	MIN	MAX	MIN	DIM
	0.180	0.169	4.57	4.30	А
	0.010	0.000	0.25	0.00	A1
DOCU	0.033	0.026	0.85	0.65	b
Z8B0	0.045	0.037	1.15	0.95	b2
	0.026	0.013	0.65	0.33	С
SCALE	0.055	0.046	1.40	1.17	c2
	0.372	0.335	9.45	8.51	D
	0.311	0.280	7.90	7.10	D1
	0.406	0.386	10.31	9.80	E
0	0.339	0.256	8.60	6.50	E1
	00	0.1	2.54		е
	0.200		5.08		e1
EUROPEAN	2	2	2	1	N
LONOI LA	0.625	0.575	15.88	14.61	Н
	0.118	0.090	3.00	2.29	L
	0.063	0.028	1.60	0.70	L1
	0.070	0.039	1.78	1.00	L2
	0.640	0.632	16.25	16.05	F1
ISSU	0.374	0.366	9.50	9.30	F2
30-0	0.185	0.177	4.70	4.50	F3
	0.429	0.421	10.90	10.70	F4
RE	0.152	0.144	3.85	3.65	F5
	0.057	0.049	1.45	1.25	F6





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Figure B. Definition of switching losses

SIS



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